

3M Scotch-Weld™ Potting Compound/Adhesive DP-270 Clear and Black

Technical Data

June, 2002

Product Description

3M™ Scotch-Weld™ Adhesive DP-270 (or Scotch-Weld Adhesive 270 B/A) is a two-part, low viscosity epoxy resin system designed primarily for potting, sealing, and encapsulation of many electronic components. It is available in clear or black. Scotch-Weld DP-270 adhesive is noncorrosive to copper and offers good thermal shock resistance and excellent retention of electrical insulation properties under high humidity conditions.

Scotch-Weld DP-270 adhesive has a work life of approximately 70 minutes, a tack-free time of about 3 hours and is fully cured after 48 hours at 73°F (23°C). This product produces no exotherm in 5-10 gram masses and a very slight exotherm in larger masses.

The Scotch-Weld DP-270 adhesive system is ideal for the potting and encapsulation of many heat sensitive or delicate components such as glass diodes and sensors as well as for transformers, coils, chokes, relays, etc. It is available in the convenient 3M™ Scotch-Weld™ EPX™ Applicator System for multi-station usage and in bulk containers for larger volume applications.

Available in larger containers as 3M™ Scotch-Weld™ Adhesive 270 B/A.

Features

- Clear or Black
- Good Thermal Shock Resistance
- Meets UL 94 HB (File No. E61941)
- Long Worklife
- Excellent Electrical Properties
- Noncorrosive to Copper
- Negligible Exotherm

Typical Uncured Properties

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Color:	Clear or Black
Base Resin:	Epoxy/amine
Mix Ratio:	1:1 by volume (1:0.85 B:A by weight)
Net Weight: Lbs./Gal.	Base 9.6 - 9.8 Accelerator 8.0 - 8.2
Worklife:	60-70 minutes @ 23°C (73°F)
Viscosity: @ 23°C (73°F)	Base 7000 - 16,000 cps Accelerator 6000 - 12,000 cps

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Typical Cured Properties

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Physical:	
Color	Clear or Black
Refractive Index @ 25°C (77°C)	Clear 1.656
Cure Shrinkage	.08%
Shore D Hardness (ASTM D-2240)	83
Tack-free Time	Approx. 3 hrs. @ 23°C (73°F)
UL Rating	94 HB (File No. E61941)
Cure Time	48 hrs. @ 23°C (73°F)
Thermal:	
Weight Loss by TGA (in air)	1% @ 122°C (252°F) 5% @ 175°C (347°F) 10% @ 210°C (410°F)
Thermal Coefficient of Expansion by TMA	
Below Tg	80 x 10 ⁻⁶ units/unit/°C 5-30°C range (10-86°F range)
Above Tg	180 x 10 ⁻⁶ units/unit/°C 60-125°C range (140-257°F)
Glass Transition Temperature by DSC	
Onset	43°C (109°F)
Mid-Point	49°C (120°F)
Thermal Conductivity (@ 110°F on .250" samples)	
BTU - ft./ft. ² - hr. - °F	.103
Cal./sec. - cm - °C	.426 x 10 ³
Watt/m - °C	.177
Thermal Shock Resistance	
Potted Washer Olyphant Test	Pass 5 Cycles without cracking
3M Test Method C-3174	
+100°C (air) to -50°C (liquid)	
Electrical:	
Dielectric Constant (ASTM D-150)	3.5 @ 1 KHz @ 23°C (73°F)
Dissipation Factor (ASTM D-150)	.018 @ 1 KHz @ 23°C (73°F)
Dielectric Strength (ASTM D-149)	850 volts/mil
Volume Resistivity (ASTM D-257)	4.1 x 10 ¹⁴ ohm-cm
Insulation Resistance (.8 mm/.8 mm comb pattern on FR-4) 60°C/96% R.H./100 volts d.c.)	
Initial	3 x 10 ¹³ ohms
1000 hrs.	2 x 10 ¹¹ ohms

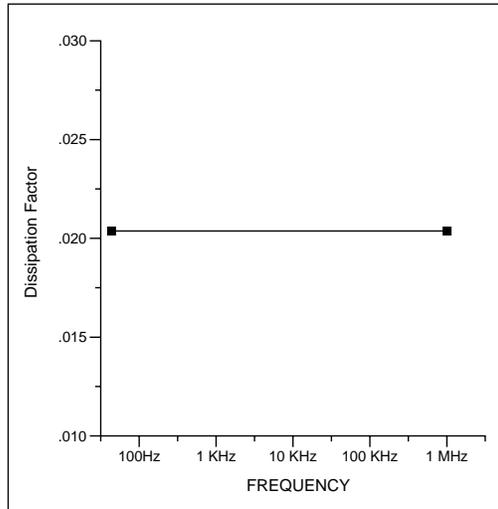
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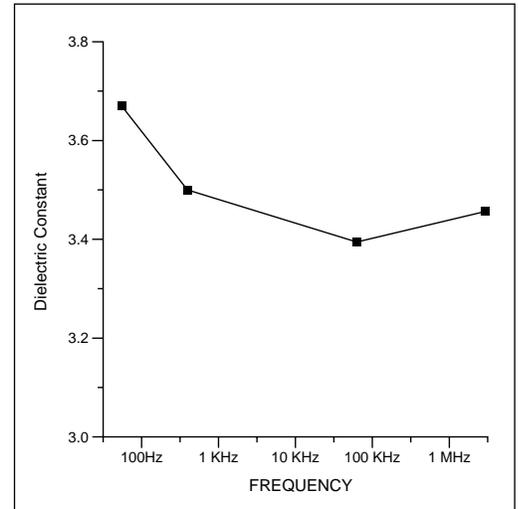
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Additional Electrical Properties for Scotch-Weld DP-270

Dissipation Factor Versus Frequency

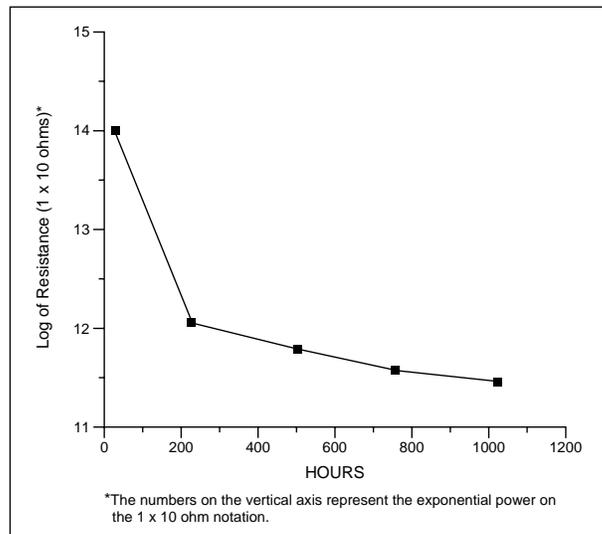


Dielectric Constant Versus Frequency



Insulation Resistance

.8 mm/.8 mm Comb Pattern
60°C (140°F)/95% RH/100 V d.c.



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Typical Cured Properties (continued)

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Corrosion:

Per ASTM D-3492 (35°C/95°F/96% R.H./45V d.c./15 days)	Pass - No copper corrosion
Per 3M Test Method C-708 (45°C/113°F/96% R.H./250V d.c./5 days)	Pass - No copper corrosion
(65°C/149°F/96% R.H./250V d.c./4 days)	Pass - No copper corrosion
Per Mil S-46163 (10 days/50% R.H./23°C/73°F)	Pass - No aluminum, brass or steel discoloration or corrosion

Solvent Resistance:

(Visual check after immersion in specified solvent at 23°C (73°F))

	1 Hour	1 Month
Acetone	B	C
Isopropyl Alcohol	A	B
Freon TF	A	A
Freon TMC	B	C
1,1,1-Trichloroethane	A	C
RMA Flux	A	B

Key: **A** - Unaffected
B - Slight Attack
C - Moderate/Severe Attack

Handling/Curing Information

Directions for use.

1. For high strength structural bonds, paint, oxide films, oils, dust, mold release agents and all other surface contaminants must be completely removed. However, the amount of surface preparation directly depends on the required bond strength and the environmental aging resistance desired by user. For specific surface preparations on common substrates, see the following section on Surface Preparation.
2. These products consist of two parts.

Mixing

For Duo-Pak Cartridges

3M™ Scotch-Weld™ Adhesive DP-270 Clear and Black are supplied in a dual syringe plastic Duo-Pak cartridge as part of the 3M™ Scotch-Weld™ EPX™ Applicator systems. To use, simply insert the Duo-Pak cartridge into the EPX applicator and start the plunger into the cylinders using light pressure on the trigger. Next, remove the Duo-Pak cartridge cap and expel a small amount of adhesive to be sure both sides of the Duo-Pak cartridge are flowing evenly and freely. If mixing of Part A and Part B is desired, attach the EPX mixing nozzle to the Duo-Pak cartridge and begin dispensing the adhesive. For hand mixing, expel the desired amount of material and mix thoroughly to obtain a uniform color.

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Handling/Curing Information *(continued)*

For Bulk Containers

Mix thoroughly by weight or volume in the proportions specified in the Typical Uncured Properties Section. Mix thoroughly to obtain a uniform color.

3. For maximum bond strength apply product evenly to both surfaces to be joined.
4. Application to the substrates should be made within 70 minutes. Larger quantities and/or higher temperatures will reduce this working time.
5. Join the adhesive coated surfaces and allow to cure at 60°F (16°C) or above until firm. Heat up to 200°F (93°C) will speed curing.
6. The following times and temperatures will result in a full cure of these products.

23°C (73°F)	48 Hours
50°C (122°F)	4 Hours
80°C (176°F)	60 Minutes
100°C (212°F)	30 Minutes

7. Keep parts from moving during cure. Contact pressure necessary. Maximum shear strength is obtained with a 3-5 mil bond line.
8. Excess uncured adhesive can be cleaned up with ketone type solvents*.

***Note: When using solvents, extinguish all ignition sources and follow the manufacturer's precautions and directions for use.**

Adhesion Coverage: A 0.005 in. thick bondline will yield a coverage of 320 sq. ft./gallon

Application and Equipment Suggestions

These products may be applied by spatula, trowel or flow equipment.

Two part mixing/proportioning/dispensing equipment is available for intermittent or production line use. These systems are ideal because of their variable shot size and flow rate characteristics and are adaptable to most applications.

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Surface Preparation

For high strength structural bonds, paint, oxide films, oils, dust, mold release agents and all other surface contaminants must be completely removed. However, the amount of surface preparation directly depends on the required bond strength and the environmental aging resistance desired by user.

The following cleaning methods are suggested for common surfaces:

Steel

1. Wipe free of dust with oil-free solvent such as acetone, isopropyl or alcohol solvents.*
2. Sandblast or abrade using clean fine grit abrasives.
3. Wipe again with solvent to remove loose particles.
4. If a primer is used, it should be applied within 4 hours after surface preparation. If 3M™ Scotch-Weld™ Structural Primer 1945 B/A is used, apply a thin coating (0.5 mils) on the metal surfaces to be bonded, air dry for 10 minutes, then cure for 30 minutes at 180°F (82°C) prior to bonding.

Aluminum

1. Vapor Degrease: Perchloroethylene condensing vapors for 5 - 10 minutes.
2. Alkaline Degrease: Oakite 164 solution (9-11 oz./gallon water) at 190°F ± 10°F (88°C ± 5°C) for 10-20 minutes. Rinse immediately in large quantities of cold running water.
3. Acid Etch: Place panels in the following solution for 10 minutes at 150°F ± 5°F (66°C ± 2°C).

Sodium Dichromate	4.1 - 4.9 oz./gallon
Sulfuric Acid, 66°Be	38.5 - 41.5 oz./gallon
2024-T3 aluminum (dissolved)	0.2 oz./gallon minimum
Tap Water as needed to balance	
4. Rinse: Rinse panels in clear running tap water.
5. Dry: Air dry 15 minutes; force dry 10 minutes at 150°F ± 10°F (66°C ± 5°C).
6. If primer is to be used, it should be applied within 4 hours after surface preparation.

Plastics/Rubber

1. Wipe with isopropyl alcohol.*
2. Abrade using fine grit abrasives.
3. Wipe with isopropyl alcohol.*

Glass

1. Solvent wipe surface using acetone or MEK.*
2. Apply a thin coating (0.0001 in. or less) of 3M™ Scotch-Weld™ Primer EC-3901 to the glass surfaces to be bonded and allow the primer to dry 60 minutes before bonding.

***Note: When using solvents, extinguish all ignition sources and follow the manufacturer's precautions and directions for use.**

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Typical Adhesive Performance Characteristics

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Although 3M™ Scotch-Weld™ Adhesive DP-270 and 270 B/A can be used for many potting and encapsulation applications, they can also be used as adhesives. The following shows typical shear and peel values determined on several common substrates:

Overlap Shear Adhesion (ASTM D-1002-72)

	Curing Conditions 7 days/73°F (23°C)	
Alum.Alum. (etched)	@-67°F (-55°C)	1200-1250 psi
	@73°F (23°C)	2450-2500 psi
	@180°F (82°C)	300-350 psi
FR-4/FR-4 (MEK Wiped)	@73°F (23°C)	1750-1800 psi
Copper/Copper (MEK Wiped)	@73°F (23°C)	1700-1750 psi
90° T-Peel Adhesion (ASTM D-1876-61T)		
Alum./Alum. (etched)	@73°F (23°C)	< 2 piw
Compression strength (ASTM D-695-68T)		
Scotch-Weld Adhesive DP-270 Clear and Black	@73°F (23°C)	8100 psi

Storage and Shelf Life

Storage: Store product at 60-80°F (16-27°C) for maximum storage life.

Shelf Life: These products when stored in original, unopened container have a shelf life of 2 years for bulk containers and 15 months in Duo-Pak containers.

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Precautionary Information

Refer to Product Label and Material Safety Data Sheet for health and safety information before using this product. For additional health and safety information, call 1-800-364-3577 or (651) 737-6501.

For Additional Information

To request additional product information or to arrange for sales assistance, call toll free 1-800-362-3550 or visit www.3M.com/adhesives. Address correspondence to: 3M Engineered Adhesives Division, 3M Center, Building 220-7E-01, St. Paul, MN 55144-1000. Our fax number is 651-733-9175. In Canada, phone: 1-800-364-3577. In Puerto Rico, phone: 1-787-750-3000. In Mexico, phone: 52-70-04-00.

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ISO 9002

This Engineered Adhesives Division product was manufactured under a 3M quality system registered to ISO 9002 standards.



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